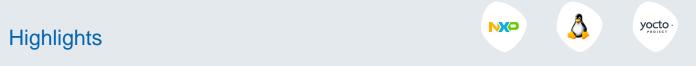


SoMs Arm® Architecture

# miriac® MPX-LS1046A

Low energy class server module with quad Arm® Cortex®-A72 cores and up to two 10 GbE



- 4 Arm® Cortex®-A72 64-bit cores at up to 1.6 GHz core frequency
- Up to 8 GB 64-bit DDR4 ECC RAM at 2100 MTps
- On-board QSPI NOR flash for a reliable boot process
- Temperature sensor
- All on board supply voltages are monitored by a separate µ-controller
- Control of on board voltages and the reset logic offer a wide spectrum of custom functionality, even low level safety functions



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## **Product Description**

New cost effective MPX-2 System on Module form factor, connecting to a standard edge connector (MXM3.0 socket).

#### **Features** CPU Architecture: Arm® Cortex®-A72 Processor: NXP® QorIQ® LS1046A CPU: 4 ARM® Cortex®-A72 64-bit cores at up to 1.6 GHz core frequency DRAM: Up to 8 GB 64-bit DDR4 ECC RAM at 2100 MT/s Memory Flash: up to 2 GB SLC NAND Flash & up to 64 MB QuadSPI Flash Flash Card: SDHC Boot Flash: QSPI, SD/MMC, NAND Flash eMMC: 8-bit **EEPROM**: Yes Ethernet 10GbE: 2x XFI **RGMII:** 2x SGMII: 5x 1Gbs, 3x 2.5Gbs QSGMII: 1x 5Gbs **TSN / IEEE 1588:** Yes **High Speed IO** SerDes lanes: 8x SerDes lanes at 10 Gbps USB 3.0: 3x (Host / Client / OTG) PCIe: 3x PCIe Gen3 (x4lane support) SATA: 1x GEN3 Security / Safety Security Engine (SEC) SFP, CSU Security: **Operating Condition** Single 5 to 12 V DC input supply voltage range Power Supply Voltage: Typical Power Consumption: 7W Power Management: Yes RTC: Epson RX-8803LC 0 °C to 70 °C Temperature: **Optional Extended Temperature:** -40 °C to +85 °C Mechanical

62 mm x 82 mm

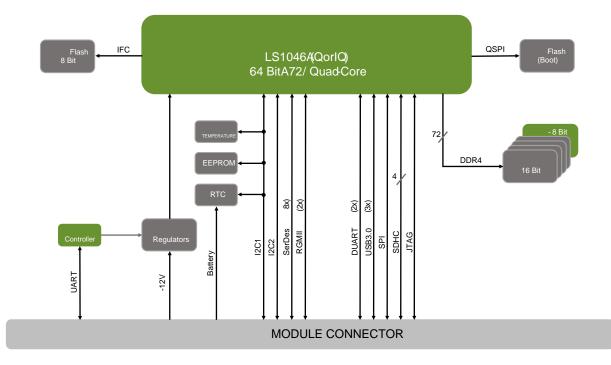
Dimensions:

Connector Type:	MPX-2 for MXM3.0 socket
Software / Additional	
Software Support:	- Linux
	- VxWorks (on request)
	- Others (on request)
Additional:	- Compatible variants available with QorIQ LS1023A, LS1043A, LS1048A, LS1088A
	- Temperature sensor
	<ul> <li>Dev Kit available for immediate start, includes power supply, cables. Linux on SD card</li> </ul>

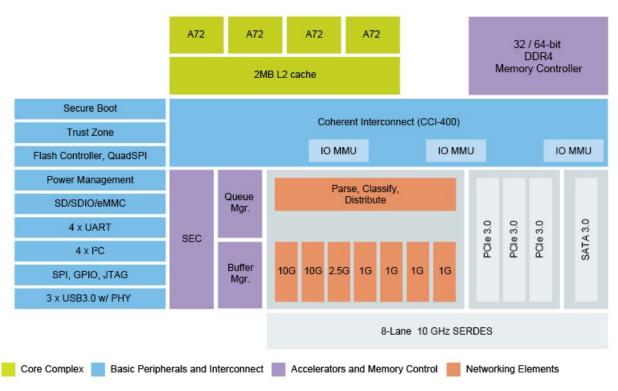
### General Note:

Our standard product versions offer what we consider to be the optimum configuration in terms of performance, price, usage and TDP. The product features lists specify the maximum range of functions per interface. However, not all interfaces or functions are always available in parallel. Flexible SERDES multiplexing is one of the reasons for this. In addition, we provide multiple memory expansion options and are also happy to accommodate specific customer wishes. So do not hesitate to <u>contact us</u> directly to discuss your desired configuration.

## Block Diagrams



### miriac® MPX-LS1046A QorlQ LS1046A PROCESSOR BLOCK DIAGRAM



NXP® Layerscape LS1046A



## Order Info

Name	Code	Description	Status
miriac® MPX-LS1046A	855615	4 Arm® Cortex®-A72, 1.6 GHz, 4 GB DDR4 w ECC, 16 MB NOR Flash, 512 MB NAND Flash, 0 °C to 70 °C, w/o SEC, MCU 10 Gbit/s	active
Development Kit basic for miriac® MPX-LS1046A	8559	<ul> <li><u>miriac® MPX-LS1046A</u></li> <li><u>CRX05</u></li> <li>incl. BSP and accessories</li> </ul>	active
Development Kit pro for miriac® MPX-LS1046A	8564	<ul> <li><u>miriac® MPX-LS1046A</u></li> <li><u>CRX06-TSN</u></li> <li>incl. BSP and accessories</li> </ul>	active

## Related Products

NameDescriptionImagemiriac® SBC-LS1046Amiriac® SBC-LS1046A-TSN





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